

# Applications

Electric rice cooker, electric pot, and controller for other heater

## **Precautions on Usage**

When the BCR2PM-12 is used, do not attach the heat radiating fin.

## **Maximum Ratings**

Parameter WWW.	Symbol	Voltage class	l Init	
Parameter	Symbol	12	Unit	
Repetitive peak off-state voltage <sup>Note1</sup>	V <sub>DRM</sub>	600	V	
Non-repetitive peak off-state voltage <sup>Note1</sup>	V <sub>DSM</sub>	720	V	



### BCR2PM-12

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I <sub>T (RMS)</sub>	2	A	Commercial frequency, sine full wave 360° conduction
Surge on-state current	I <sub>TSM</sub>	10	A	60Hz sinewave 1 full cycle, peak value, non-repetitive
I <sup>2</sup> t for fusing	l <sup>2</sup> t	0.41	A <sup>2</sup> s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P <sub>GM</sub>	1	W	
Average gate power dissipation	P <sub>G (AV)</sub>	0.1	W	
Peak gate voltage	V <sub>GM</sub>	6	V	
Peak gate current	I <sub>GM</sub>	1	А	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	—	2.0	g	Typical value

Notes: 1. Gate open.

### **Electrical Characteristics**

Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions	
Repetitive peak off-state current		I <sub>DRM</sub>	_	_	0.5	mA	$Tj = 125^{\circ}C, V_{DRM}$ applied	
On-state voltage		V <sub>TM</sub>		_	1.6	V	$Tj = 25^{\circ}C, I_{TM} = 1.5 A,$	
							Instantaneous measurement	
Gate trigger voltage <sup>Note2</sup>	II	$V_{RGTI}$		_	2.0	V	$Tj=25^{\circ}C,\ V_{D}=6\ V,\ R_{L}=6\ \Omega,$	
	III	V <sub>RGTIII</sub>	—	—	2.0	V	$R_{G} = 330 \Omega$	
Gate trigger current <sup>Note2</sup>	II	I <sub>RGTI</sub>			10	mA	$\label{eq:Tj} \begin{split} &Tj = 25^\circC, \ V_D = 6 \ V, \ R_L = 6 \ \Omega, \\ &R_G = 330 \ \Omega \end{split}$	
	III	I <sub>RGTIII</sub>	_	_	10	mA		
Gate non-trigger voltage		$V_{GD}$	0.1	_	_	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM}$	
Thermal resistance		R <sub>th (j-a)</sub>	_	_	40	°C/W	Junction to ambient,	
							Natural convection	

Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

### **Performance Curves**







### BCR2PM-12

# **Package Dimensions**



# **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example		
Straight type	Vinyl sack	100	Type name +RA	BCR2PM-12RA		
Lead form	Plastic Magazine (Tube)	50	Type name +RA – Lead forming code	BCR2PM-12RA-A8		
Note - Disease confirm the encodingation should the chinging in detail						

Note : Please confirm the specification about the shipping in detail.

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